

CXP测试座脚位表 (部分)

CXP series Pad position List



PKG Image	PKG Size (mm)	PKG Thickness (mm)	Pin Counts	Socket Part Number	PKG Image	PKG Size (mm)	PKG Thickness (mm)	Pin Counts	Socket Part Number
	1x0.8	0.12	4	CXP-P04-05-00		5x3.2	1.25	2	CXP-C02-01-00
	1x0.8	0.25	4	CXP-P04-13-00		5x3.2	1.42	2	CXP-C02-12-00
	1.6x1.2	0.15	4	CXP-L04-12-00		5x3.2	0.6	2	CXP-C02-08-00
	1.6x1.2	0.5	4	CXP-L04-11-00		5x3.2	0.95	2	CXP-C02-03-00
	2x1.2	0.37	2	CXP-K02-08-00		5x3.2	1.25	2	CXP-C02-04-00
	2x1.2	0.5	2	CXP-K02-04-00		5x3.2	0.8	4	CXP-C04-27-00
	2x1.6	0.7	4	CXP-K04-19-00		5x3.2	1.0	4	CXP-C04-29-00
	2x1.6	0.85	4	CXP-K04-30-00		5x3.2	0.75	4	CXP-C04-25-00
	2x1.6	0.6	4	CXP-K04-28-00		5x3.2	1.1	4	CXP-C04-06-00
	2x1.6	0.65	4	CXP-K04-13-00		5x3.2	1.5	4	CXP-C04-28-00
	2x1.6	0.95	4	CXP-K04-10-00		5x3.2	1.2	6	CXP-C06-11-00
	2.5x2	0.65	4	CXP-I04-23-00		5x3.2	1.4	6	CXP-C06-02-00
	2.5x2	0.8	4	CXP-I04-01-00		5x3.2	1.05	8	CXP-C08-02-00
	2.5x2	0.5	4	CXP-I04-09-00		5x3.2	1.6	8	CXP-C08-10-00
	2.5x2	0.55	4	CXP-I04-10-00		5x3.2	1.7	8	CXP-C08-07-00
	2.5x2	0.75	4	CXP-I04-16-00		5x3.2	0.9	10	CXP-C10-05-00
	2.5x2	0.78	4	CXP-I04-03-00		5x3.2	1.0	10	CXP-C10-06-00
	2.5x2	0.82	4	CXP-I04-07-00		5x3.2	1.6	10	CXP-C10-04-00
	2.5x2	0.88	4	CXP-I04-04-00		7x5	0.8	2	CXP-A02-07-00
	2.5x2	0.9	4	CXP-I04-08-00		7x5	1.0	2	CXP-A02-06-00
	2.5x2	1.0	4	CXP-I04-13-00		7x5	1.15	4	CXP-A04-17-00
	2.5x2	1.0	6	CXP-I06-12-00		7x5	1.3	4	CXP-A04-15-00
	2.5x2	0.8	6	CXP-I06-13-00		7x5	1.4	4	CXP-A04-21-00
	2.5x2	0.95	4	CXP-I04-24-00		7x5	1.8	4	CXP-A04-10-00
	3.2x2.5	0.89	2	CXP-G02-13-00		7x5	0.9	4	CXP-A04-30-00
	3.2x2.5	1.15	2	CXP-G02-01-00		7x5	1.5	4	CXP-A04-31-00
	3.2x2.5	0.7	2	CXP-G02-11-00		7x5	2.5	4	CXP-A04-42-00
	3.2x2.5	0.75	2	CXP-G02-09-00		7x5	0.85	6	CXP-A06-26-00
	3.2x2.5	0.9	4	CXP-G04-06-00		7x5	1.45	6	CXP-A06-16-00
	3.2x2.5	0.92	4	CXP-G04-09-00		7x5	1.75	6	CXP-A06-31-00
	3.2x2.5	1.2	4	CXP-G04-24-00		7x5	1.85	6	CXP-A06-32-00
	3.2x2.5	0.55	4	CXP-G04-01-00		7x5	0.9	6	CXP-A06-29-00
	3.2x2.5	0.6	4	CXP-G04-04-00		7x5	1.15	6	CXP-A06-01-00
	3.2x2.5	0.65	4	CXP-G04-15-00		7x5	1.5	8	CXP-A08-11-00
	3.2x2.5	0.75	6	CXP-G06-10-00		7x5	1.7	8	CXP-A08-14-00
	3.2x2.5	0.85	6	CXP-G06-08-00		7x5	2.05	8	CXP-A08-10-00
	3.2x2.5	1.0	6	CXP-G06-04-00		7x5	1.38	10	CXP-A10-07-00
	3.2x2.5	0.84	8	CXP-G08-07-00		7x5	1.9	10	CXP-A10-02-00
	3.2x2.5	0.9	8	CXP-G08-05-00		7x5	1.7	10	CXP-A10-01-00
	3.2x2.5	1.05	8	CXP-G08-01-00		7x5	1.8	10	CXP-A10-10-00



致力于高新技术与创新解决方案
High technology and innovative solutions



下压式测试座
Open-top Type
(CXC series)



翻盖式测试座
Clam-shell Type
(CXP series)



蝴蝶式测试座
Butterfly Type
(CXX series)

Your solution for global needs



微机电测试座
MEMS Type
(SEN series)



小型贴片测试座
Small Type
(CAP series)



3D打印测试座
3D Printer Type
(Special series)

本表为部分CXP测试座型号，特殊需求或其他类型测试座请与我们联系

 <p>エム・アイ・エス テクノロジー株式会社 MIS Technologies Corporation</p> <p>TEL +81-42-770-9425</p> <p>WEB www.mis-tech.jp</p> <p>ADDRESS Sagamihara Sangyo Sozo Center#306 5-4-30 Nishihashinoto Midori-ku Sagamihara Kanagawa 252-0131 Japan</p>	<p>優力精密工業有限公司 AFORCE PRECISION INDUSTRY CORPORATION</p> <p>+886-3-6571238</p> <p>www.aforce.tw</p> <p>30251 新竹縣竹北市縣政十街207號</p>	<p>昆山优力技鑫精密机械有限公司 AFORCE Unitech Precision Machinery Co., Ltd</p> <p>0512-57865729 / 185-5006-2076</p> <p>www.mis-socket.com</p> <p>江苏省昆山市经济技术开发区中航城58-102号</p>
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翻盖式测试座

Clam-shell Type (CXP series)

PKG : 1.0x0.8 - 34.3x25.4mm ,
PIN : 2pin - 12pin ,
超过1000种常规规格 ,
单尺寸种类丰富多元, 例: 50种14X9mm测座。
可根据产品定制(Customized sockets available).



Close



CXP系列利用蚌壳结构与悬臂盖和探针接触。它是理想的工程评估和测试用测试座。

CXP series utilize Clam-shell structure with a cantilever cover and pogo pin contacts. It is ideal for engineering evaluation and tests.

下压式测试座

Open-top Type (CXC series)

PKG : 2.05x1.65 - 7.35x4.95等 ,
PIN : 2pin - 10pin ,
Stamped 接触, 可检测底面和侧边, 更适用于自动化批量测试。
可根据产品定制(Customized sockets available)。



CXC系列采用开放式顶部结构与冲压簧片接触。它是自动化生产测试的理想选择。

CXC series utilize Open-top structure with stamped contacts. It is ideal for automated production systems.



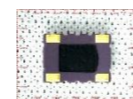
特性 FEATURES

- ✓ 精确可靠的频率控制装置
- ✓ 理想的接触力度, 避免测量误差
- ✓ 提供最高质量的插座
- ✓ 蚌壳式设计, 易于开启和关闭
- ✓ 可靠耐用的镀金弹针
- ✓ 适用于长期高温老化测试
- ✓ 工作温度: -35°C ~ +150°C

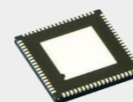


- ✓ Accurate and reliable testing of frequency control devices
- ✓ Contact force ideal for avoiding measurement error
- ✓ Highest quality socket available
- ✓ Clam shell design for easy open and close
- ✓ Reliable gold plated POGO pins
- ✓ Suitable for high temperature burn-in test
- ✓ Operating Temperature: -35 ~ +150°C

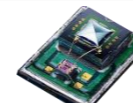
应用 APPLICATIONS



谐振器 & 晶体 Oscillator & Crystal
温补晶振 / 恒温晶振 / 压控晶振 / 振荡器用



半导体 Semiconductor
SOP / QFN / SON / SOT / TO / CSP



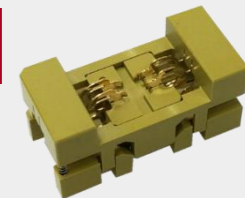
微机电 MEMS
陀螺仪 / 压力用 / 气体用 / 加速度



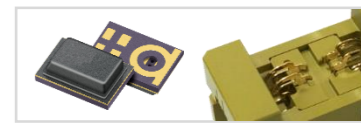
老化测试 Aging
低温-45°C / 高温+150°C

微机电测试座

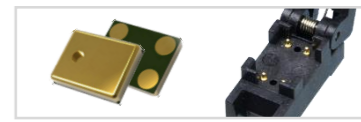
MEMS Type (SEN series)



Open-top (下压式), 适用于下进音麦克风产品。
可根据产品定制。
(Customized sockets available)



Clam-shall (翻盖式), 适用于上进音麦克风产品。
可根据产品定制。
(Customized sockets available)



SEN系列针对MEMS麦克风产品进行特殊设计优化。可满足①电器性能测试②声音检测。

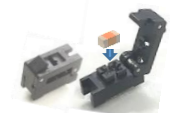
- ①Socket to confirm only PKG conduction.
- ②Socket structure listened sound.

小型贴片测试座

Small Type (CAP series)



PKG : 2.0x1.2mm, 1.6x0.8mm, 1.0x0.5mm 等,
PIN : 2pin ,
可根据产品定制(Customized sockets available).

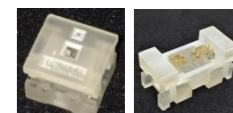


3D打印测试座

3D Printer Type (Special series)



微机电麦克风插座
用3D打印机制作的部件-底座, 盖子
开顶式插座
用3D打印机组件-底座, 盖子, 插销
可根据产品定制(Customized sockets available).



适用于原型, 接受1件订单, 低成本快速交货。

Suitable for prototype, Accept order from 1 piece. Low cost & short delivery.

Malaysia	CETC 十三所CETC	惠伦Failong	晶宝CREC(SC)	Hosonic 鸿星Hosonic	大普DAPU
China	CEC 熊猫CEC Xtal	ECEC 东晶ECEC	晶源JYEG	晨晶ChenJing	天奥ELECSPN
Thailand					
Hong Kong					
Russia					
Taiwan	TXC 台晶TXC	SIWARD 希华Siward	TST 嘉硕TST	AKER 安基AKER	
Singapore	TAITIEN 泰艺Taitien	MELC 码居礼Mercury	加高HELE	YOKE 友桂YOKETAN	
Italy	EPSON 爱普生Seikoepson	YAMAHA 雅马哈Yamaha	KYOCERA 京瓷Kyocera	NDK 日本电工NDK	RIVER 大河River Ele
UK	OMRON 欧姆龙Omuron	KDS 大真空KDS	CITIZEN 西铁城Citizen	muRata 牧田Murata	JRC 日本无线JRC
Japan					
Philippines	SAMSUNG 三星Samsung	H&S High Tech	SUNNY 阳光Sunny	EXA EXA	
Korea					
Germany	BOSCH 博世Bosch				
USA					
New Zealand	rakon 锐康Rakon				
France					
Switzerland	MC 微晶Micro Crystal				

2009年度“300家活跃的中小型企业”

经济贸易工业部从2006年起, 每年从技术先进的中小型企业中, 评选出“300家活跃的中小型企业”。
In Ministry of Economy, Trade and industry, it commends a small and medium-sized manufacturing enterprise with a superior technique with the choice every year “300 active small and medium-sized manufacturing enterprise” from 2006.

MiS技术公司 (MiS) 专门生产电子器件的测试插座(Socket), 如石英晶体器件、MEMS传感器、MEMS和C-MOS振荡器器件、电容器和光学器件。MiS为石英晶体器件市场提供了多种多样的Socket, 可以满足绝大多数客户的封装类型和尺寸。
随着汽车技术的进步, 先进电子设备不断被开发并应用于高度集成的电子汽车系统。MiS所生产得各种测试插座, 可用于燃烧和可靠性测量, 以满足这些行业特定的要求。MiS技术公司不断致力于满足和超越严格的全球高质量要求的测试插座的设计、制造和销售。我们致力于成为客户的“一站式解决方案”。

MiS Technologies Corporation
President Ichiro Midorikawa

Apr.2000	Founded Moved into Sagami-hara Incubation Center Ltd.
Jun.2000	Developed TCXO (7x5) socket, the smallest.
Nov.2000	Developed TCXO (6x3.5) socket.
Aug.2001	Developed TCXO (5x3.2) socket, the smallest. Developed TCXO (4x2.5) socket.
Jun.2002	Developed TCXO (3.2x2.5) socket, the smallest.
Jan.2005	Developed TCXO (2.5x2) socket, the smallest.
Oct.2006	Developed TCXO (2x1.6) socket.
Mar.2008	Developed Oscillator (1.2x1) socket.
Jun.2009	Received an award from METI (Ministry of Economy, Trade and Industry), as one of “300 active small and medium-sized manufacturing enterprise”.
Jul.2012	Developed TCXO (1.6x1.2) socket, the smallest.
Jun.2013	Developed 66 kinds of MEMS sockets.
Sep.2013	Developed OCXO high-volume production socket (for great current).
Aug.2014	Developed Fine pitch socket (0.3mm/0.35mm pitch).
May.2015	Developed MEMS oscillator (1x0.8) socket.

